

# SN74LVC1G123 Single Retriggerable Monostable Multivibrator With Schmitt-Trigger Inputs

## 1 Features

- Available in the Texas Instruments NanoFree™ Package
- Supports 5V  $V_{CC}$  Operation
- Inputs Accept Voltages to 5.5V
- Max  $t_{pd}$  of 8ns at 3.3V
- Supports Mixed-Mode Voltage Operation on All Ports
- Supports Down Translation to  $V_{CC}$
- Schmitt-Trigger Circuitry on  $\bar{A}$  and B Inputs for Slow Input Transition Rates
- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Very Long Output Pulses, Up to 100% Duty Cycle
- Overriding Clear Terminates Output Pulse
- Glitch-Free Power-Up Reset on Outputs
- $I_{off}$  Supports Live Insertion, Partial-Power-Down Mode, and Back-Drive Protection
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000V Human-Body Model (A114-A)
  - 200V Machine Model (A115-A)
  - 1000V Charged-Device Model (C101)

## 2 Applications

- AV Receivers
- Blu-ray Players and Home Theaters
- DVD Recorders and Players
- Desktop PCs or Notebook PCs
- Digital Radio and Internet Radio Players
- Digital Video Cameras (DVC)
- Embedded PCs
- GPS: Personal Navigation Devices
- Mobile Internet Devices
- Network Attached Storage (NAS)
- Personal Digital Assistant (PDA)
- Server PSU
- Solid-State Drive (SSD): Client and Enterprise
- Video Analytics Servers
- Wireless Headsets, Keyboards, and Mice

## 3 Description

The SN74LVC1G123 device is a single retriggerable monostable multivibrator designed for 1.65V to 5.5V  $V_{CC}$  operation.

This monostable multivibrator features output pulse-duration control by three methods. In the first method, the  $\bar{A}$  input is low, and the B input goes high. In the second method, the B input is high, and the  $\bar{A}$  input goes low. In the third method, the  $\bar{A}$  input is low, the B input is high, and the clear ( $\overline{CLR}$ ) input goes high.

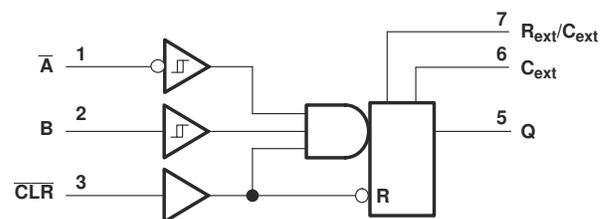
The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between  $C_{ext}$  and  $R_{ext}/C_{ext}$  (positive) and an external resistor connected between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . To obtain variable pulse durations, connect an external variable resistance between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . The output pulse duration also can be reduced by taking  $\overline{CLR}$  low.

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The  $\bar{A}$  and B inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

### Device Information

| PART NUMBER  | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM) |
|--------------|------------------------|-----------------|
| SN74LVC1G123 | SSOP (8)               | 2.95mm × 2.80mm |
|              | VSSOP (8)              | 2.30mm × 2.00mm |
|              | DSBGA (8)              | 1.91mm × 0.91mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



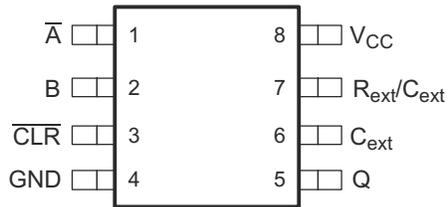
Logic Diagram (Positive Logic)



## Table of Contents

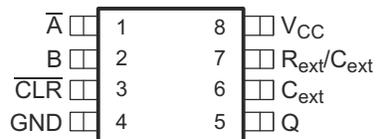
|  |    |  |    |
|--|----|--|----|
| <b>1 Features</b> .....  | 1  | 7.1 Overview.....  | 12 |
| <b>2 Applications</b> .....  | 1  | 7.2 Functional Block Diagram.....                                | 12 |
| <b>3 Description</b> .....   | 1  | 7.3 Feature Description.....                                     | 12 |
| <b>4 Pin Configuration and Functions</b> .....   | 3  | 7.4 Device Functional Modes.....                                 | 13 |
| <b>5 Specifications</b> .....  | 4  | <b>8 Application and Implementation</b> .....                    | 14 |
| 5.1 Absolute Maximum Ratings.....  | 4  | 8.1 Application Information.....                                 | 14 |
| 5.2 ESD Ratings.....   | 4  | 8.2 Typical Application.....                                     | 14 |
| 5.3 Recommended Operating Conditions.....  | 4  | <b>9 Power Supply Recommendations</b> .....                      | 16 |
| 5.4 Thermal Information.....   | 5  | <b>10 Layout</b> .....   | 16 |
| 5.5 Electrical Characteristics.....  | 5  | 10.1 Layout Guidelines.....                                      | 16 |
| 5.6 Timing Requirements.....   | 6  | 10.2 Layout Example.....   | 16 |
| 5.7 Switching Characteristics, $C_L = 15$ pF, $-40^\circ\text{C}$ to $85^\circ\text{C}$ .....  | 7  | <b>11 Device and Documentation Support</b> .....                 | 17 |
| 5.8 Switching Characteristics, $C_L = 50$ pF, $-40^\circ\text{C}$ to $85^\circ\text{C}$ .....  | 7  | 11.1 Documentation Support.....                                  | 17 |
| 5.9 Switching Characteristics, $C_L = 50$ pF, $-40^\circ\text{C}$ to $125^\circ\text{C}$ ..... | 7  | 11.2 Receiving Notification of Documentation Updates..           | 17 |
| 5.10 Operating Characteristics.....  | 8  | 11.3 Support Resources.....                                      | 17 |
| 5.11 Typical Characteristics.....  | 9  | 11.4 Trademarks.....   | 17 |
| <b>6 Parameter Measurement Information</b> .....   | 10 | 11.5 Electrostatic Discharge Caution.....                        | 17 |
| <b>7 Detailed Description</b> .....  | 12 | 11.6 Glossary.....   | 17 |
|  |    | <b>12 Revision History</b> .....                                 | 17 |
|  |    | <b>13 Mechanical, Packaging, and Orderable Information</b> ..... | 18 |

## 4 Pin Configuration and Functions

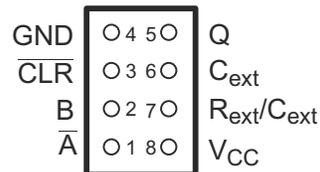


See mechanical drawings for dimensions.

**Figure 4-1. DCT Package 8-Pin SSOP Top View**



**Figure 4-2. DCU Package 8-Pin VSSOP Top View**



**Figure 4-3. YZP Package 8-Pin DSBGA Bottom View**

**Table 4-1. Pin Functions**

| PIN               |     | I/O | DESCRIPTION   |
|-------------------|-----|-----|---|
| NAME              | NO. |     |   |
| $\bar{A}$         | 1   | I   | Falling edge sensitive input; requires B and $\bar{CLR}$ to be held high.                                       |
| B                 | 2   | I   | Rising edge sensitive input; requires $\bar{A}$ to be held low and $\bar{CLR}$ to be held high.                 |
| $\bar{CLR}$       | 3   | I   | Clear, Active Low; also can operate as rising edge sensitive input if $\bar{A}$ is held low and B is held high. |
| GND               | 4   | —   | Ground  |
| Q                 | 5   | O   | Output  |
| $C_{ext}$         | 6   | —   | Connects only to the external capacitor   |
| $R_{ext}/C_{ext}$ | 7   | —   | Connects to the external capacitor and resistor   |
| $V_{CC}$          | 8   | —   | Power   |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |   | MIN                | MAX                   | UNIT |
|------------------|---|--------------------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage  | -0.5               | 6.5                   | V    |
| V <sub>I</sub>   | Input voltage <sup>(2)</sup>  | -0.5               | 6.5                   | V    |
| V <sub>O</sub>   | Voltage applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5               | 6.5                   | V    |
| V <sub>O</sub>   | Voltage applied to any output in the high or low state <sup>(2)</sup> (3)             | -0.5               | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current   |                    | -50                   | mA   |
|                  |   | V <sub>I</sub> < 0 |                       |      |
| I <sub>OK</sub>  | Output clamp current  |                    | -50                   | mA   |
|                  |   | V <sub>O</sub> < 0 |                       |      |
| I <sub>O</sub>   | Continuous output current   |                    | ±50                   | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND                                     |                    | ±100                  | mA   |
| T <sub>stg</sub> | Storage temperature   | -65                | 150                   | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(3) The value of V<sub>CC</sub> is provided in the *Recommended Operating Conditions* table.

### 5.2 ESD Ratings

|                    |                         | VALUE  | UNIT  |
|--------------------|-------------------------|--|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | +2000 |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | +1000 |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                           | MIN                                | MAX                    | UNIT |
|-----------------|---------------------------|------------------------------------|------------------------|------|
| V <sub>CC</sub> | Supply voltage            | Operating                          | 1.65                   | 5.5  |
|                 |                           | Data retention only                | 1.5                    |      |
| V <sub>IH</sub> | High-level input voltage  | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |      |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V     | 2                      |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | 0.7 × V <sub>CC</sub>  |      |
| V <sub>IL</sub> | Low-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.35 × V <sub>CC</sub> | V    |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V   | 0.7                    |      |
|                 |                           | V <sub>CC</sub> = 3 V to 3.6 V     | 0.8                    |      |
|                 |                           | V <sub>CC</sub> = 4.5 V to 5.5 V   | 0.3 × V <sub>CC</sub>  |      |
| V <sub>I</sub>  | Input voltage             | 0                                  | 5.5                    | V    |
| V <sub>O</sub>  | Output voltage            | 0                                  | V <sub>CC</sub>        | V    |
| I <sub>OH</sub> | High-level output current | V <sub>CC</sub> = 1.65 V           | -4                     | mA   |
|                 |                           | V <sub>CC</sub> = 2.3 V            | -8                     |      |
|                 |                           | V <sub>CC</sub> = 3 V              | -16                    |      |
|                 |                           |                                    | -24                    |      |
|                 |                           | V <sub>CC</sub> = 4.5 V            | -32                    |      |

### 5.3 Recommended Operating Conditions (continued)

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                 |                                | MIN                      | MAX | UNIT |
|---------------------------------|--------------------------------|--------------------------|-----|------|
| I <sub>OL</sub>                 | Low-level output current       | V <sub>CC</sub> = 1.65 V | 4   | mA   |
|                                 |                                | V <sub>CC</sub> = 2.3 V  | 8   |      |
|                                 |                                | V <sub>CC</sub> = 3 V    | 16  |      |
|                                 |                                |                          | 24  |      |
|                                 |                                | V <sub>CC</sub> = 4.5 V  | 32  |      |
| R <sub>ext</sub> <sup>(2)</sup> | External timing resistance     | V <sub>CC</sub> = 2 V    | 5   | kΩ   |
|                                 |                                | V <sub>CC</sub> ≥ 3 V    | 1   |      |
| T <sub>A</sub>                  | Operating free-air temperature | -40                      | 125 | °C   |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, [SCBA004](#).

(2) R<sub>ext</sub>/C<sub>ext</sub> is an I/O and must not be connected directly to GND or V<sub>CC</sub>.

### 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> | SN74LVC1G123                           |             |             | UNIT |      |
|-------------------------------|--|-------------|-------------|------|------|
|                               | DCT (SSOP)                             | DCU (VSSOP) | YZP (DSBGA) |      |      |
|                               | 8 PINS                                 | 8 PINS      | 8 PINS      |      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance | 220         | 227         | 102  | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

### 5.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS   | V <sub>CC</sub>   | -40°C TO 85°C         |                    |     | -40°C TO 125°C        |                    |     | UNIT |    |
|------------------|---|---|-----------------------|--------------------|-----|-----------------------|--------------------|-----|------|----|
|                  |   |   | MIN                   | TYP <sup>(1)</sup> | MAX | MIN                   | TYP <sup>(1)</sup> | MAX |      |    |
| V <sub>OH</sub>  | I <sub>OH</sub> = -100 μA<br>I <sub>OH</sub> = -4 mA<br>I <sub>OH</sub> = -8 mA<br>I <sub>OH</sub> = -16 mA<br>I <sub>OH</sub> = -24 mA<br>I <sub>OH</sub> = -32 mA | 1.65 V to 5.5 V   | V <sub>CC</sub> - 0.1 |                    |     | V <sub>CC</sub> - 0.1 |                    |     | V    |    |
|                  |   | 1.65 V  | 1.2                   |                    |     | 1.2                   |                    |     |      |    |
|                  |   | 2.3 V   | 1.9                   |                    |     | 1.9                   |                    |     |      |    |
|                  |   | 3 V   | 2.4                   |                    |     | 2.4                   |                    |     |      |    |
|                  |   |   | 2.3                   |                    |     | 2.3                   |                    |     |      |    |
|                  |   | 4.5 V   | 3.8                   |                    |     | 3.8                   |                    |     |      |    |
| V <sub>OL</sub>  | I <sub>OL</sub> = 100 μA<br>I <sub>OL</sub> = 4 mA<br>I <sub>OL</sub> = 8 mA<br>I <sub>OL</sub> = 16 mA<br>I <sub>OL</sub> = 24 mA<br>I <sub>OL</sub> = 32 mA       | 1.65 V to 5.5 V   | 0.1                   |                    |     | 0.1                   |                    |     | V    |    |
|                  |   | 1.65 V  | 0.45                  |                    |     | 0.45                  |                    |     |      |    |
|                  |   | 2.3 V   | 0.3                   |                    |     | 0.3                   |                    |     |      |    |
|                  |   | 3 V   | 0.4                   |                    |     | 0.4                   |                    |     |      |    |
|                  |   |   | 0.55                  |                    |     | 0.55                  |                    |     |      |    |
|                  |   | 4.5 V   | 0.55                  |                    |     | 0.55                  |                    |     |      |    |
| I <sub>I</sub>   | R <sub>ext</sub> /C <sub>ext</sub> <sup>(2)</sup><br>B = GND, $\bar{A} = \bar{CLR} = V_{CC}$<br>$\bar{A}, B, \bar{CLR}$   | 1.65 V to 5.5 V   | ±0.25                 |                    |     | ±0.25                 |                    |     | μA   |    |
|                  |   |   | ±1                    |                    |     | ±1                    |                    |     |      |    |
| I <sub>off</sub> | $\bar{A}, B, Q, \bar{CLR}$  | V <sub>I</sub> or V <sub>O</sub> = 5.5 V  | 0                     |                    |     | ±10                   |                    |     | μA   |    |
| I <sub>CC</sub>  | Quiescent   | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                                       | 5.5 V                 |                    |     | 20                    |                    |     | μA   |    |
| I <sub>CC</sub>  | Active state  | V <sub>I</sub> = V <sub>CC</sub> or GND, R <sub>ext</sub> /C <sub>ext</sub> = 0.5 V <sub>CC</sub> | 1.65 V                | 165                |     |                       | 165                |     |      | μA |
|                  |   |   | 2.3 V                 | 220                |     |                       | 220                |     |      |    |
|                  |   |   | 3 V                   | 280                |     |                       | 280                |     |      |    |
|                  |   |   | 4.5 V                 | 650                |     |                       | 650                |     |      |    |
|                  |   |   | 5.5 V                 | 975                |     |                       | 975                |     |      |    |

### 5.5 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER      | TEST CONDITIONS                         | V <sub>CC</sub> | -40°C TO 85°C |                    |     | -40°C TO 125°C |                    |     | UNIT |
|----------------|---|-----------------|---------------|--------------------|-----|----------------|--------------------|-----|------|
|                |   |                 | MIN           | TYP <sup>(1)</sup> | MAX | MIN            | TYP <sup>(1)</sup> | MAX |      |
| C <sub>I</sub> | V <sub>I</sub> = V <sub>CC</sub> or GND | 3.3 V           | 3             |                    |     |                |                    |     | pF   |

- (1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.
- (2) This test is performed with the terminal in the OFF-state condition.

### 5.6 Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 6-1)

| PARAMETER                            | TEST CONDITIONS         | -40°C TO 125°C                   |     |                                 |     |                                 |     |                               |     | UNIT |
|--------------------------------------|-------------------------|----------------------------------|-----|---------------------------------|-----|---------------------------------|-----|-------------------------------|-----|------|
|                                      |                         | V <sub>CC</sub> = 1.8 V ± 0.15 V |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | V <sub>CC</sub> = 3.3 V ± 0.3 V |     | V <sub>CC</sub> = 5 V ± 0.5 V |     |      |
|                                      |                         | MIN                              | TYP | MIN                             | TYP | MIN                             | TYP | MIN                           | TYP |      |
| t <sub>wIN</sub> Pulse duration      | CLR                     | 8                                |     | 4                               |     | 3                               |     | 2.5                           |     | ns   |
|                                      | $\bar{A}$ or B trigger  | 8                                |     | 4                               |     | 3                               |     | 2.5                           |     |      |
| t <sub>rr</sub> Pulse retrigger time | R <sub>ext</sub> = 1 kΩ | C <sub>ext</sub> = 100 pF        |     |                                 |     |                                 | 5.5 |                               | 4.5 | ns   |
|                                      |                         | C <sub>ext</sub> = 100 μF        |     |                                 |     |                                 | 1.4 |                               | 1.1 | μs   |
|                                      | R <sub>ext</sub> = 5 kΩ | C <sub>ext</sub> = 100 pF        |     | 75                              |     | 45                              |     |                               |     | ns   |
|                                      |                         | C <sub>ext</sub> = 100 μF        |     | 1.8                             |     | 1.4                             |     |                               |     | μs   |

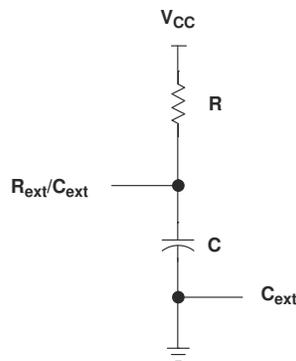


Figure 5-1. Required Timing Circuit

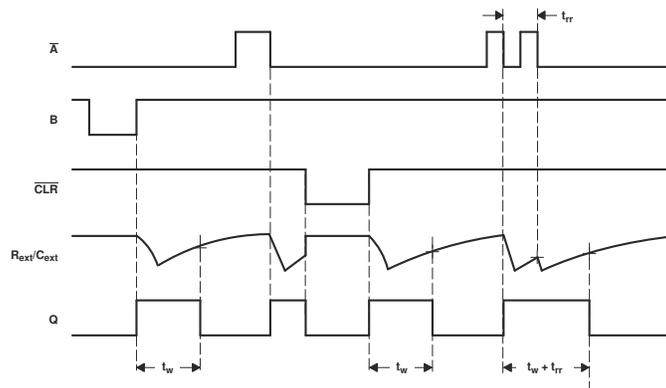


Figure 5-2. Input/Output Timing Diagram

### 5.7 Switching Characteristics, $C_L = 15 \text{ pF}$ , $-40^\circ\text{C}$ to $85^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see Figure 6-1)

| PARAMETER | FROM (INPUT)                    | TO (OUTPUT) | -40°C TO 85°C                               |      |     |  |      |  |      |  | UNIT |     |
|-----------|---------------------------------|-------------|---|------|-----|--|------|--|------|--|------|-----|
|           |                                 |             | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |      |     | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |      | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ |      |     |
|           |                                 |             | MIN   | TYP  | MAX | MIN  | MAX  | MIN  | MAX  | MIN                                      |      | MAX |
| $t_{pd}$  | $\bar{A}$ or B                  | Q           | 7   | 18.5 | 52  | 4  | 17   | 3  | 11.5 | 2  | 7.6  | ns  |
|           | $\overline{\text{CLR}}$         |             | 5   | 12.4 | 34  | 3  | 11.5 | 2  | 8    | 1.5                                      | 5.5  |     |
|           | $\overline{\text{CLR}}$ trigger |             | 7   | 17.4 | 54  | 4  | 15.5 | 3  | 10.5 | 2  | 7    |     |

### 5.8 Switching Characteristics, $C_L = 50 \text{ pF}$ , $-40^\circ\text{C}$ to $85^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 6-1)

| PARAMETER     | FROM (INPUT)                    | TO (OUTPUT) | TEST CONDITIONS  | -40°C TO 85°C                               |                    |      |  |      |  |      |  | UNIT          |     |
|---------------|---------------------------------|-------------|--|---|--------------------|------|--|------|--|------|--|---------------|-----|
|               |                                 |             |  | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |                    |      | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |      | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ |               |     |
|               |                                 |             |  | MIN   | TYP <sup>(1)</sup> | MAX  | MIN  | MAX  | MIN  | MAX  | MIN                                      |               | MAX |
| $t_{pd}$      | $\bar{A}$ or B                  | Q           |  | 6   | 18.6               | 57   | 3  | 18.5 | 2  | 12.5 | 1.5                                      | 8.2           | ns  |
|               | $\overline{\text{CLR}}$         |             |  | 4   | 11.6               | 36.5 | 2  | 12.5 | 1.5  | 8.6  | 1.5                                      | 6             |     |
|               | $\overline{\text{CLR}}$ trigger |             |  | 5   | 17.3               | 59   | 2.5  | 17   | 2  | 11.5 | 1.5                                      | 7.5           |     |
| $t_{wOUT(2)}$ |                                 | Q           | $C_{ext} = 28 \text{ pF}$ ,<br>$R_{ext} = 2 \text{ k}\Omega$             | 225   | 600                | 190  | 220  | 170  | 200  | 150  | 180                                      | ns            |     |
|               |                                 |             | $C_{ext} = 0.01 \text{ }\mu\text{F}$ ,<br>$R_{ext} = 10 \text{ k}\Omega$ | 100   | 110                | 100  | 110  | 100  | 110  | 100  | 110                                      | $\mu\text{s}$ |     |
|               |                                 |             | $C_{ext} = 0.1 \text{ }\mu\text{F}$ ,<br>$R_{ext} = 10 \text{ k}\Omega$  | 1   | 1.1                | 1    | 1.1  | 1    | 1.1  | 1    | 1.1                                      | ms            |     |

(1)  $T_A = 25^\circ\text{C}$

(2)  $t_w$  = Duration of pulse at Q output

### 5.9 Switching Characteristics, $C_L = 50 \text{ pF}$ , $-40^\circ\text{C}$ to $125^\circ\text{C}$

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 6-1)

| PARAMETER     | FROM (INPUT)                    | TO (OUTPUT) | TEST CONDITIONS  | -40°C TO 125°C                              |                    |     |  |      |  |      |  | UNIT          |     |
|---------------|---------------------------------|-------------|--|---|--------------------|-----|--|------|--|------|--|---------------|-----|
|               |                                 |             |  | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ |                    |     | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ |      | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |      | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ |               |     |
|               |                                 |             |  | MIN   | TYP <sup>(1)</sup> | MAX | MIN  | MAX  | MIN  | MAX  | MIN                                      |               | MAX |
| $t_{pd}$      | $\bar{A}$ or B                  | Q           |  | 6   |                    | 58  | 3  | 19.5 | 2  | 13.2 | 1.5                                      | 8.7           | ns  |
|               | $\overline{\text{CLR}}$         |             |  | 4   |                    | 37  | 2  | 13.5 | 1.5  | 9.2  | 1.5                                      | 6.5           |     |
|               | $\overline{\text{CLR}}$ trigger |             |  | 5   |                    | 60  | 2.5  | 18   | 2  | 12   | 1.5                                      | 8             |     |
| $t_{wOUT(2)}$ |                                 | Q           | $C_{ext} = 28 \text{ pF}$ ,<br>$R_{ext} = 2 \text{ k}\Omega$             | 225   | 600                | 190 | 220  | 170  | 200  | 150  | 180                                      | ns            |     |
|               |                                 |             | $C_{ext} = 0.01 \text{ }\mu\text{F}$ ,<br>$R_{ext} = 10 \text{ k}\Omega$ | 100   | 110                | 100 | 110  | 100  | 110  | 100  | 110                                      | $\mu\text{s}$ |     |
|               |                                 |             | $C_{ext} = 0.1 \text{ }\mu\text{F}$ ,<br>$R_{ext} = 10 \text{ k}\Omega$  | 1   | 1.1                | 1   | 1.1  | 1    | 1.1  | 1    | 1.1                                      | ms            |     |

(1)  $T_A = 25^\circ\text{C}$

(2)  $t_w$  = Duration of pulse at Q output

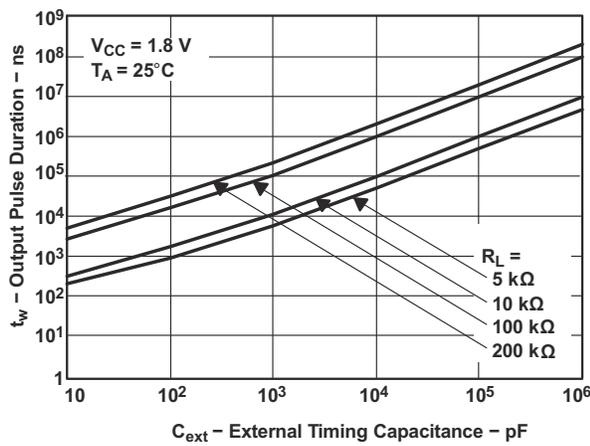
## 5.10 Operating Characteristics

 $T_A = 25^\circ\text{C}$ 

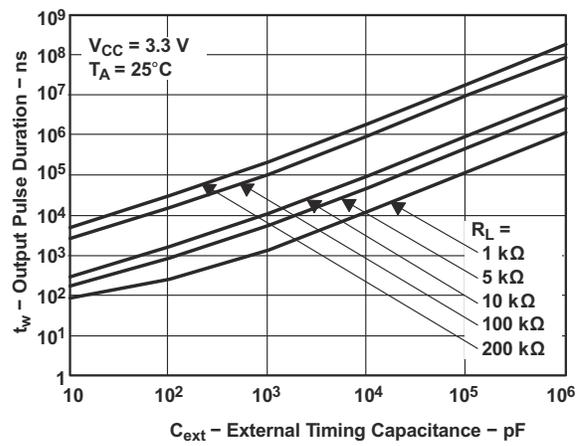
| PARAMETER                              | TEST CONDITIONS  | $V_{CC} = 1.8\text{ V}$                       | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | $V_{CC} = 5\text{ V}$ | UNIT |    |
|--|--|---|-------------------------|-------------------------|-----------------------|------|----|
|  |  | TYP   | TYP                     | TYP                     | TYP                   |      |    |
| $C_{pd}$ Power dissipation capacitance | $\bar{A} = \text{low}, B = \text{high},$<br>CLR = 10 MHz | $R_{ext} = 1\text{ k}\Omega,$<br>No $C_{ext}$ |                         |                         | 35                    | 37   | pF |
|  |  | $R_{ext} = 5\text{ k}\Omega,$<br>No $C_{ext}$ | 41                      | 40                      |                       |      |    |

### 5.11 Typical Characteristics

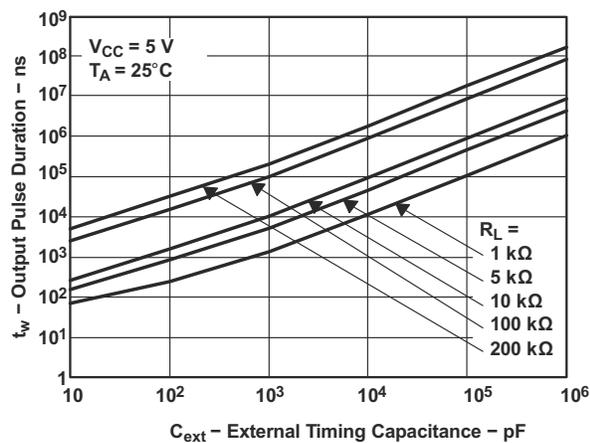
over recommended operating free-air temperature range (unless otherwise noted)



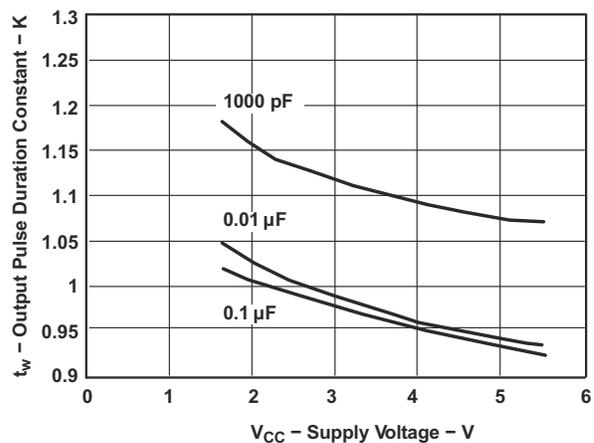
**Figure 5-3. Output Pulse Duration vs External Timing Capacitance**



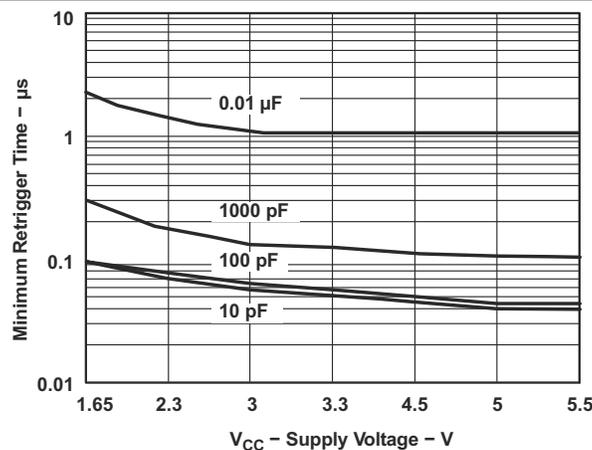
**Figure 5-4. Output Pulse Duration vs External Timing Capacitance**



**Figure 5-5. Output Pulse Duration vs External Timing Capacitance**

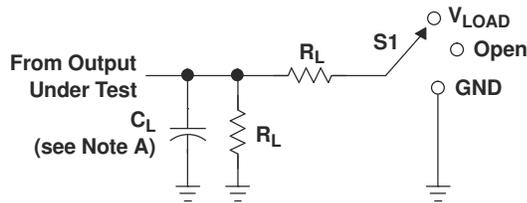


**Figure 5-6. Output Pulse Duration Constant vs Supply Voltage**



**Figure 5-7. Minimum Retrigger Time vs Supply Voltage**

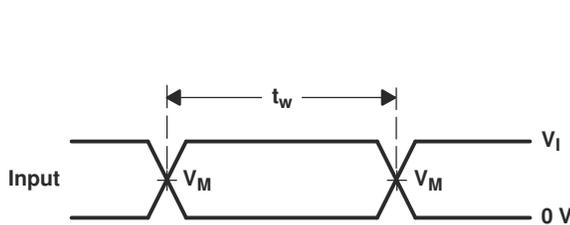
## 6 Parameter Measurement Information



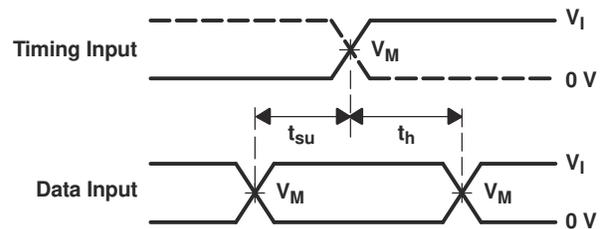
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

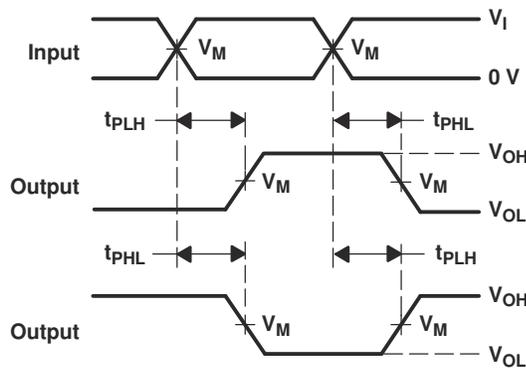
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.15 V       |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 3 V      | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 15 pF | 1 M $\Omega$ | 0.3 V        |
| $5\text{ V} \pm 0.5\text{ V}$    | $V_{CC}$ | $\leq 2.5\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 15 pF | 1 M $\Omega$ | 0.3 V        |



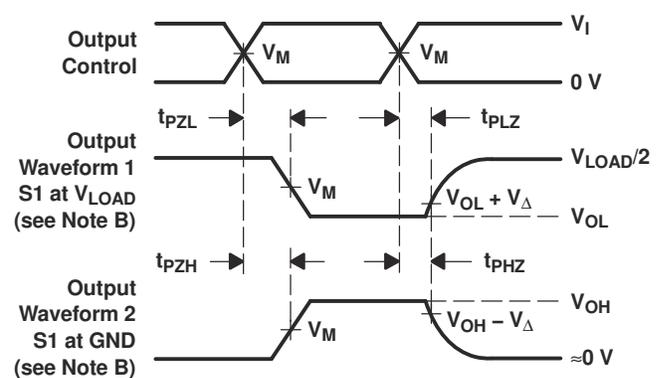
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



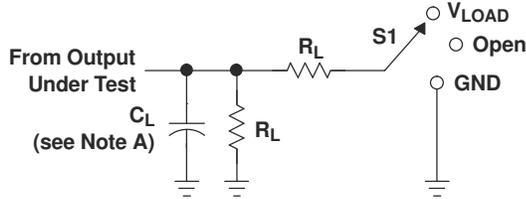
VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .  
 H. All parameters and waveforms are not applicable to all devices.

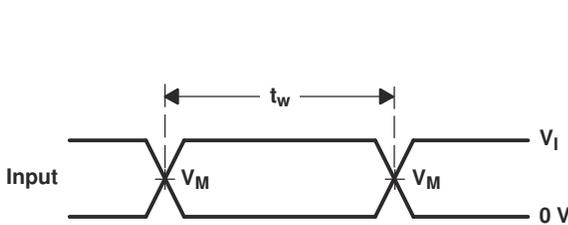
Figure 6-1. Load Circuit and Voltage Waveforms



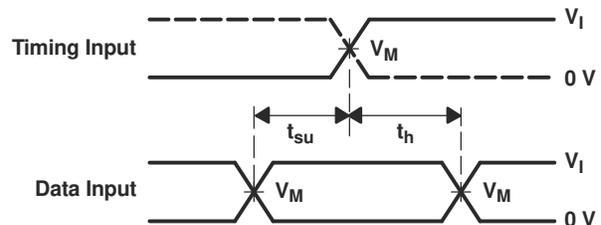
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

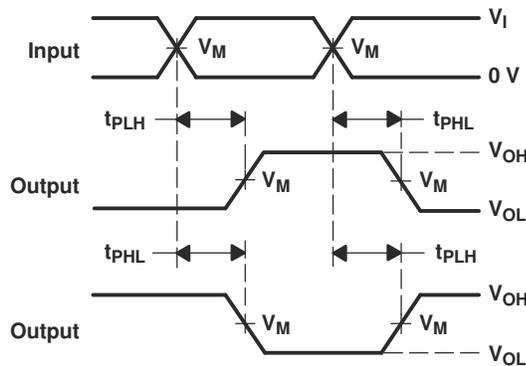
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 3 V      | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $5\text{ V} \pm 0.5\text{ V}$    | $V_{CC}$ | $\leq 2.5\text{ ns}$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50 pF | 500 $\Omega$ | 0.3 V        |



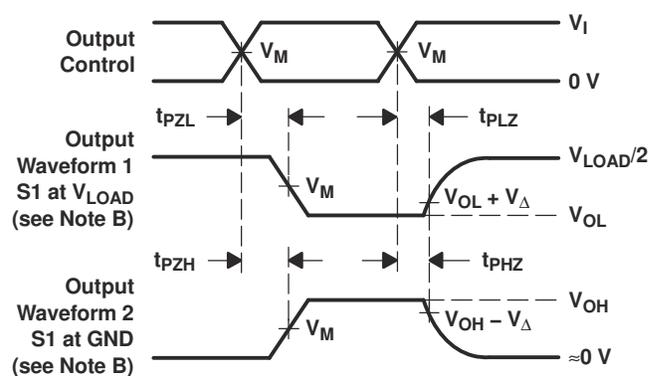
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 6-2. Load Circuit and Voltage Waveforms

## 7 Detailed Description

### 7.1 Overview

The SN74LVC1G123 device is a single retriggerable monostable multivibrator designed for 1.65-V to 5.5-V  $V_{CC}$  operation.

This monostable multivibrator features output pulse-duration control by three methods. In the first method, the  $\bar{A}$  input is low, and the B input goes high. In the second method, the B input is high, and the  $\bar{A}$  input goes low. In the third method, the  $\bar{A}$  input is low, the B input is high, and the clear ( $\overline{CLR}$ ) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between  $C_{ext}$  and  $R_{ext}/C_{ext}$  (positive) and an external resistor connected between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . To obtain variable pulse durations, connect an external variable resistance between  $R_{ext}/C_{ext}$  and  $V_{CC}$ . The output pulse duration also can be reduced by taking  $\overline{CLR}$  low.

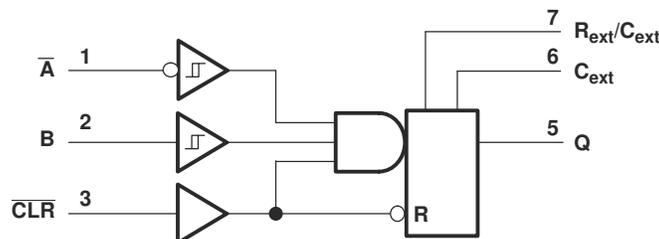
Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The  $\bar{A}$  and B inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active ( $\bar{A}$ ) or high-level-active (B) input. Pulse duration can be reduced by taking  $\overline{CLR}$  low.  $\overline{CLR}$  can be used to override  $\bar{A}$  or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The SN74LVC1G123 device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

This part is available in the Texas Instruments NanoFree™ package. It supports 5-V  $V_{CC}$  operation and accepts inputs up to 5.5 V. The max  $t_{pd}$  is 8 ns at 3.3 V. It supports mixed-mode voltage operation on all ports.

Down translation can be achieved to  $V_{CC}$  from up to 5.5 V.

Schmitt-trigger circuitry on  $\bar{A}$  and B inputs allows for slow input transition rates. The device can be edge triggered from active-high or active-low gated logic inputs. It can support up to 100% duty cycle from retriggering.

Clear can be used to terminate the output pulse early.

Glitch-free power-up reset is on all outputs.

$I_{off}$  supports live insertion, partial-power-down mode, and back-drive protection.

Latch-up performance exceeds 100 mA per JESD 78, Class II.

## 7.4 Device Functional Modes

Table 7-1 lists the functional modes for the SN74LVC1G123.

**Table 7-1. Function Table**

| INPUTS |           |   | OUTPUTS<br>Q   |
|--------|-----------|---|--|
| CLR    | $\bar{A}$ | B |  |
| L      | X         | X | L  |
| X      | H         | X | L <sup>(1)</sup>   |
| X      | X         | L | L <sup>(1)</sup>   |
| H      | L         | ↑ |  |
| H      | ↓         | H |  |
| ↑      | L         | H |  |

- (1) These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

## 8 Application and Implementation

### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The SN74LVC1G123 can be used for many applications. The application shown here is a switch debounce circuit. Many switches produce multiple triggers when pressed, and the debounce circuit turns the many triggers into one. This circuit takes advantage of the retrigger capability of the SN74LVC1G123 in that the output pulse length only has to be longer than the longest individual bounce (typically less than 1 ms).

### 8.2 Typical Application

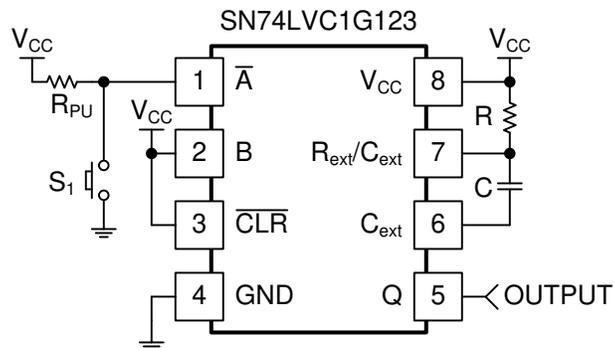


Figure 8-1. Typical Application of the SN74LVC1G123

#### 8.2.1 Design Requirements

- Recommended Input Conditions:
  - For specified high and low levels, see  $V_{IH}$  and  $V_{IL}$  in [Section 5.3](#).
  - Inputs and outputs are overvoltage tolerant, allowing them to go as high as 4.6 V at any valid  $V_{CC}$ .
- Recommended Output Conditions:
  - Load current should not exceed values listed in [Section 5.3](#).

#### 8.2.2 Detailed Design Procedure

The values for  $V_{CC}$ ,  $R_{PU}$ ,  $R$ , and  $C$  must be selected for proper operation.

$V_{CC}$  is selected at 1.8 V. This value is usually driven by the logic voltage of the system, but is arbitrary in this case.

$R_{PU}$  is selected at 10 k $\Omega$ .

$R$  and  $C$  are selected via the plots in [Section 8.2.3](#) and are based on the time desired for the output pulse. In this case, the output pulse will be 1 ms. Since the supply voltage has been selected at 1.8 V, [Figure 8-2](#) is used to determine the  $R$  and  $C$  values required. First convert the desired pulse width ( $t_w$ ), 1 ms, to ns. This yields  $10^6$  ns. Next follow that line across to see which  $R$  and  $C$  values intersect it.

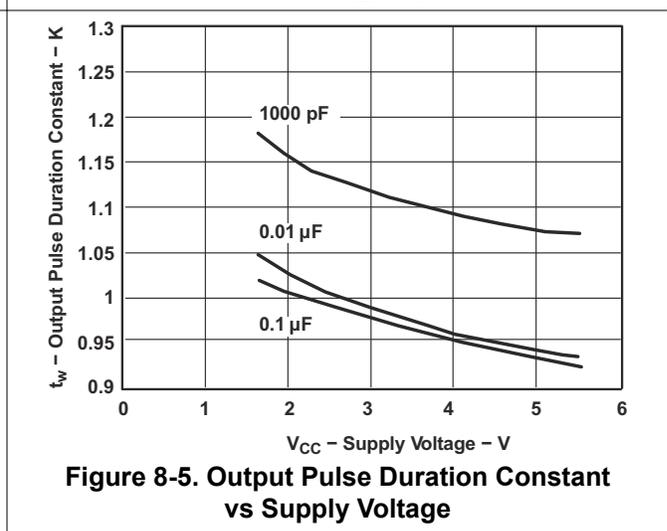
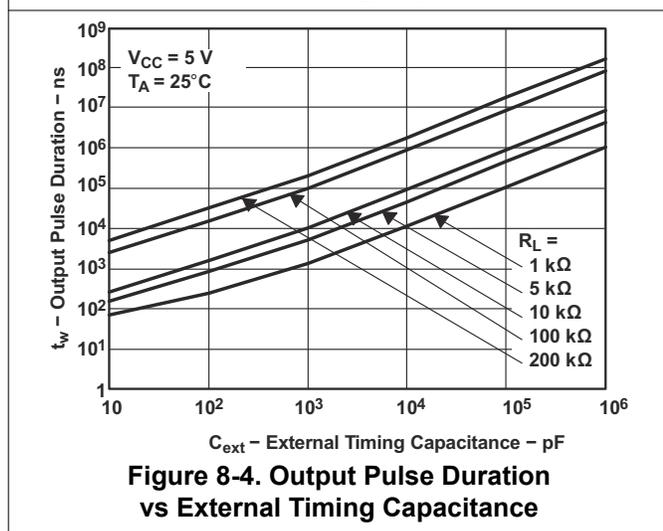
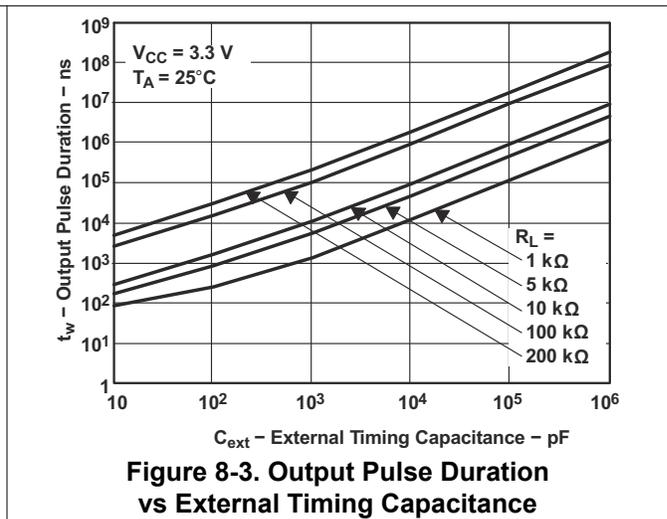
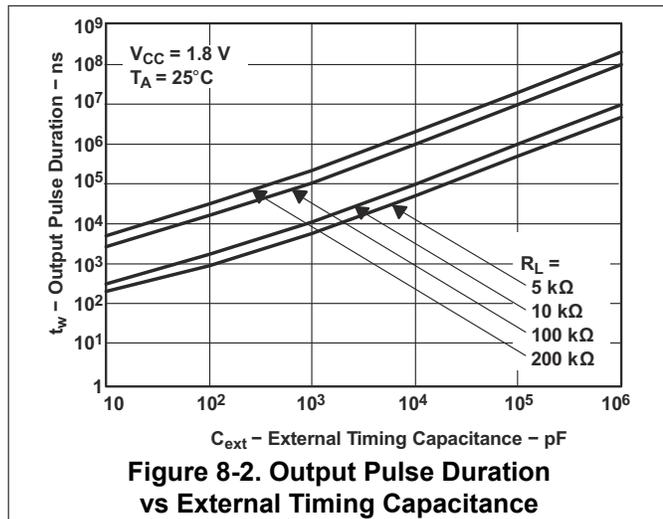
$R$  is selected at 10 k $\Omega$  because that line intersects nicely with  $10^6$  ns and  $10^5$  pF, making the selection of  $C$  at 0.1  $\mu$ F easy.

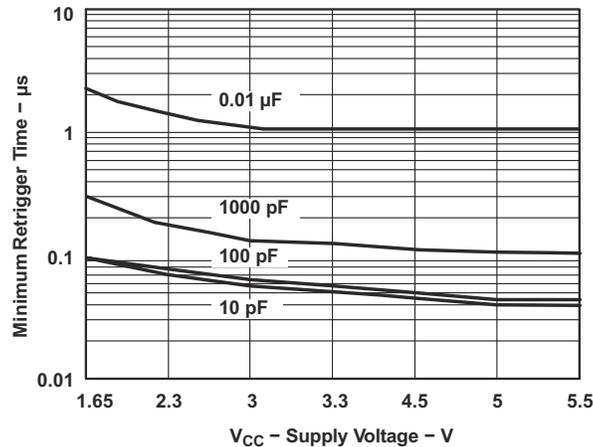
**Table 8-1. Application Specific Values**

| PARAMETER       | VALUE         |
|-----------------|---------------|
| $V_{CC}$        | 1.8 V         |
| $R_{PU}$        | 10 k $\Omega$ |
| $t_w$           | 1 ms          |
| R ( $R_{ext}$ ) | 10 k $\Omega$ |
| C ( $C_{ext}$ ) | 0.1 $\mu$ F   |

In addition to the shown components, a 0.1- $\mu$ F decoupling capacitor from  $V_{CC}$  to ground should be placed as close as possible to the device.

**8.2.3 Application Curves**





**Figure 8-6. Minimum Retrieger Time vs Supply Voltage**

## 9 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating listed in the [Section 5.3](#).

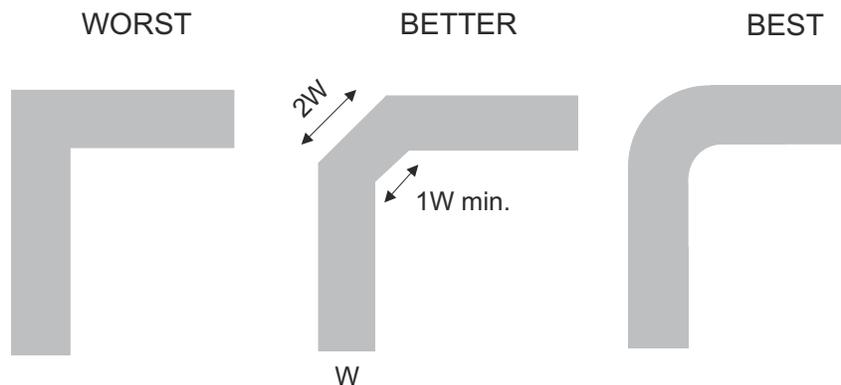
Each V<sub>CC</sub> terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1-µF bypass capacitor is recommended. If multiple pins are labeled V<sub>CC</sub>, then a 0.01-µF or 0.022-µF capacitor is recommended for each V<sub>CC</sub> because the V<sub>CC</sub> pins are tied together internally. For devices with dual-supply pins operating at different voltages, for example V<sub>CC</sub> and V<sub>DD</sub>, a 0.1-µF bypass capacitor is recommended for each supply pin. To reject different frequencies of noise, use multiple bypass capacitors in parallel. Capacitors with values of 0.1 µF and 1 µF are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

## 10 Layout

### 10.1 Layout Guidelines

Reflections and matching are closely related to the loop antenna theory but are different enough to be discussed separately from the theory. When a PCB trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self-inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. [Figure 10-1](#) shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

### 10.2 Layout Example



**Figure 10-1. Trace Example**

## 11 Device and Documentation Support

### 11.1 Documentation Support

#### 11.1.1 Related Documentation

For related documentation see the following:

*Implications of Slow or Floating CMOS Inputs*, [SCBA004](#)

### 11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](#). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 11.4 Trademarks

NanoFree™ is a trademark of Texas Instruments.

TI E2E™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

### 11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 12 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### **Changes from Revision D (June 2015) to Revision E (March 2024)** **Page**

- Updated format to match new TI layout and flow. Tables, figures and cross-references use a new numbering sequence throughout the document..... **1**

### **Changes from Revision C (October 2013) to Revision D (June 2015)** **Page**

- Added *Applications*, *Device Information* table, *Pin Configuration and Functions* section, *ESD Ratings* table, *Typical Characteristics*, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section ..... **1**
- Removed duplicate *Timing Requirements* table ..... **6**

| Changes from Revision B (January 2007) to Revision C (October 2013) | Page |
|---|------|
| • Updated document to new TI data sheet format.....                 | 1    |
| • Updated <i>Features</i> .....                                     | 1    |
| • Updated operating temperature range.....                          | 4    |
| • Added <i>Thermal Information</i> table.....                       | 5    |

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| 74LVC1G123DCTRE4 | ACTIVE        | SM8          | DCT             | 8    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| 74LVC1G123DCTRG4 | ACTIVE        | SM8          | DCT             | 8    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| 74LVC1G123DCTTE4 | ACTIVE        | SM8          | DCT             | 8    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| 74LVC1G123DCTTG4 | ACTIVE        | SM8          | DCT             | 8    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| 74LVC1G123DCURE4 | ACTIVE        | VSSOP        | DCU             | 8    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C23R                    | <a href="#">Samples</a> |
| 74LVC1G123DCURG4 | ACTIVE        | VSSOP        | DCU             | 8    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C23R                    | <a href="#">Samples</a> |
| 74LVC1G123DCUTG4 | ACTIVE        | VSSOP        | DCU             | 8    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | C23R                    | <a href="#">Samples</a> |
| SN74LVC1G123DCTR | ACTIVE        | SM8          | DCT             | 8    | 3000        | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| SN74LVC1G123DCTT | ACTIVE        | SM8          | DCT             | 8    | 250         | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (2W95, C23)<br>(R, Z)   | <a href="#">Samples</a> |
| SN74LVC1G123DCUR | ACTIVE        | VSSOP        | DCU             | 8    | 3000        | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (22FT, C23Q, C23R)      | <a href="#">Samples</a> |
| SN74LVC1G123DCUT | ACTIVE        | VSSOP        | DCU             | 8    | 250         | RoHS & Green    | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 125   | (C23J, C23Q, C23R)      | <a href="#">Samples</a> |
| SN74LVC1G123YZPR | ACTIVE        | DSBGA        | YZP             | 8    | 3000        | RoHS & Green    | SNAGCU                               | Level-1-260C-UNLIM   | -40 to 85    | (D87, D8N)              | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

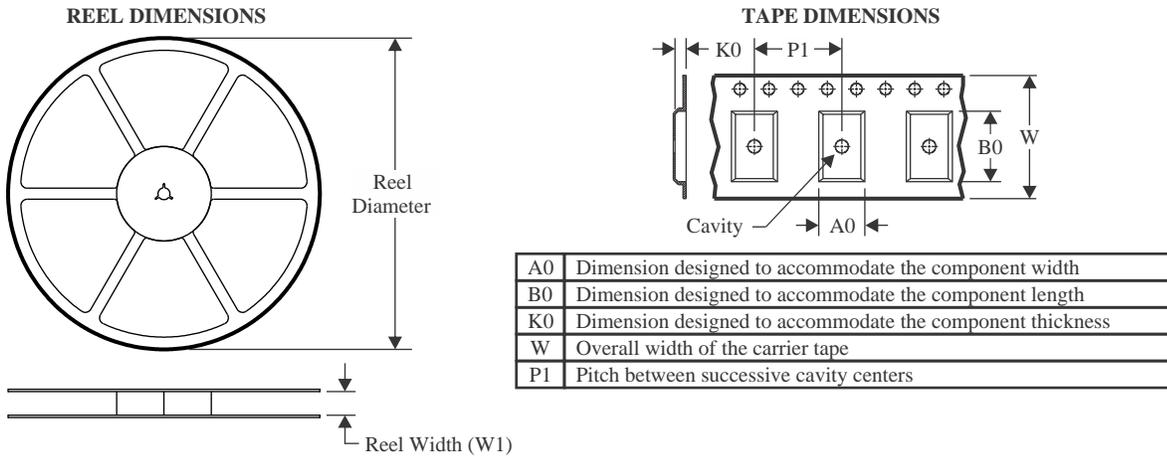
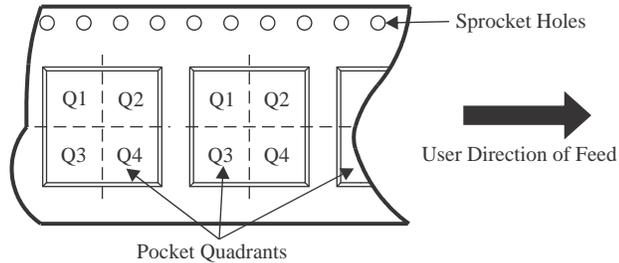
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

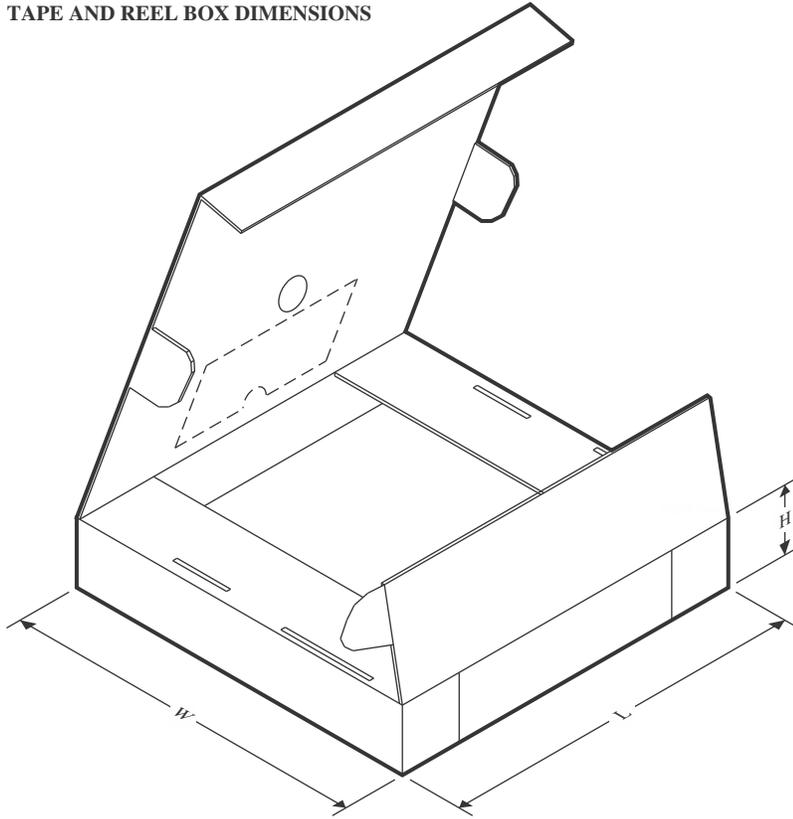
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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| 74LVC1G123DCURG4 | VSSOP        | DCU             | 8    | 3000 | 180.0              | 8.4                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| 74LVC1G123DCUTG4 | VSSOP        | DCU             | 8    | 250  | 180.0              | 8.4                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC1G123DCTR | SM8          | DCT             | 8    | 3000 | 180.0              | 12.4               | 3.15    | 4.35    | 1.55    | 4.0     | 12.0   | Q3            |
| SN74LVC1G123DCTT | SM8          | DCT             | 8    | 250  | 180.0              | 12.4               | 3.15    | 4.35    | 1.55    | 4.0     | 12.0   | Q3            |
| SN74LVC1G123DCUR | VSSOP        | DCU             | 8    | 3000 | 178.0              | 9.0                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC1G123DCUT | VSSOP        | DCU             | 8    | 250  | 178.0              | 9.5                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC1G123DCUT | VSSOP        | DCU             | 8    | 250  | 178.0              | 9.0                | 2.25    | 3.35    | 1.05    | 4.0     | 8.0    | Q3            |
| SN74LVC1G123YZPR | DSBGA        | YZP             | 8    | 3000 | 178.0              | 9.2                | 1.02    | 2.02    | 0.63    | 4.0     | 8.0    | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74LVC1G123DCURG4 | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| 74LVC1G123DCUTG4 | VSSOP        | DCU             | 8    | 250  | 202.0       | 201.0      | 28.0        |
| SN74LVC1G123DCTR | SM8          | DCT             | 8    | 3000 | 190.0       | 190.0      | 30.0        |
| SN74LVC1G123DCTT | SM8          | DCT             | 8    | 250  | 190.0       | 190.0      | 30.0        |
| SN74LVC1G123DCUR | VSSOP        | DCU             | 8    | 3000 | 180.0       | 180.0      | 18.0        |
| SN74LVC1G123DCUT | VSSOP        | DCU             | 8    | 250  | 202.0       | 201.0      | 28.0        |
| SN74LVC1G123DCUT | VSSOP        | DCU             | 8    | 250  | 180.0       | 180.0      | 18.0        |
| SN74LVC1G123YZPR | DSBGA        | YZP             | 8    | 3000 | 220.0       | 220.0      | 35.0        |

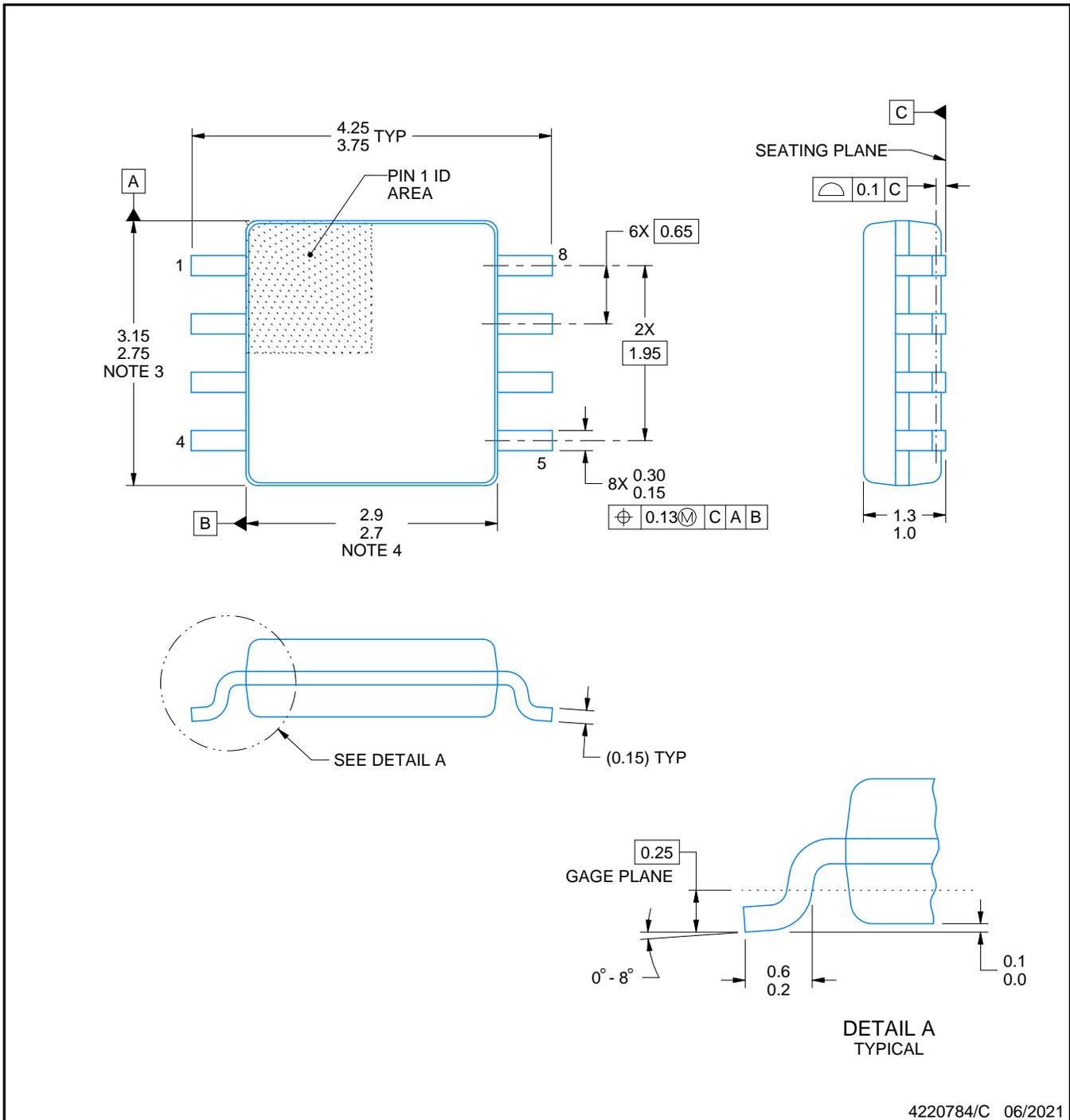


# DCT0008A

# PACKAGE OUTLINE

## SSOP - 1.3 mm max height

SMALL OUTLINE PACKAGE



### NOTES:

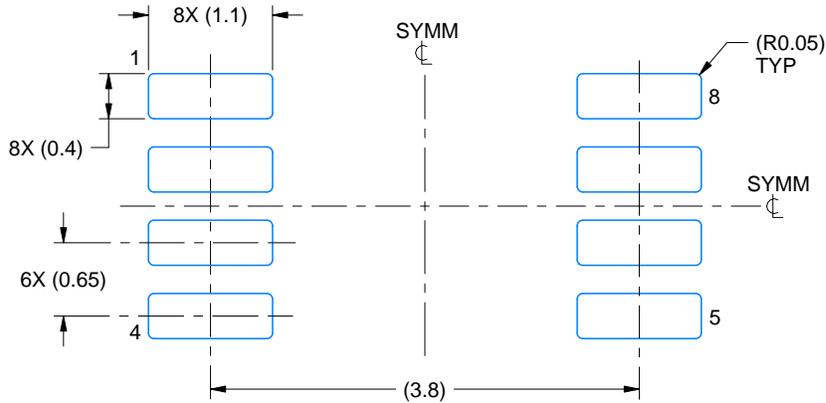
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.

# EXAMPLE BOARD LAYOUT

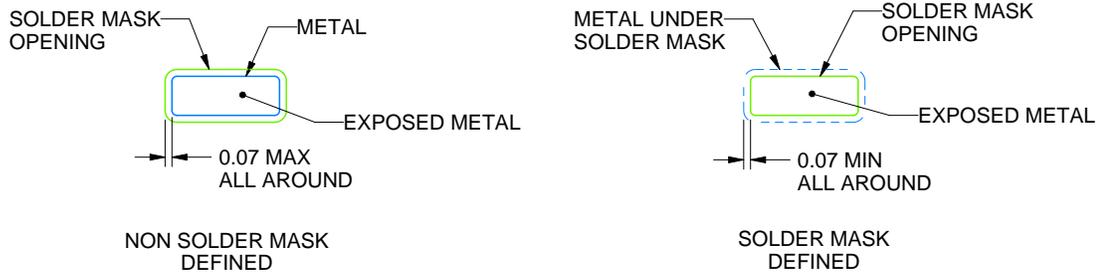
DCT0008A

SSOP - 1.3 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4220784/C 06/2021

NOTES: (continued)

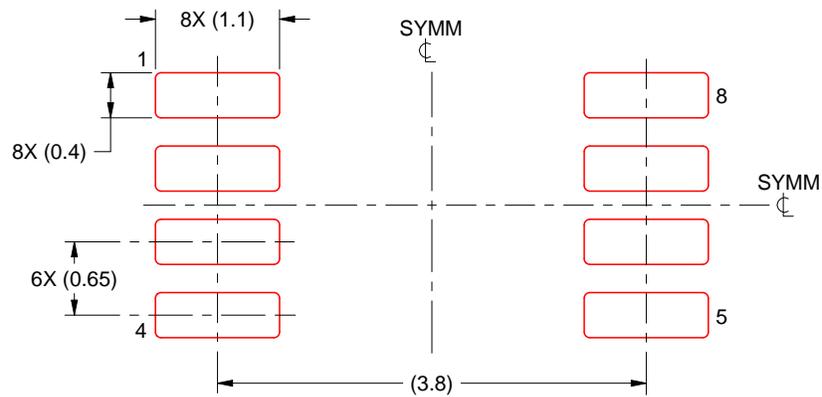
- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DCT0008A

SSOP - 1.3 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4220784/C 06/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

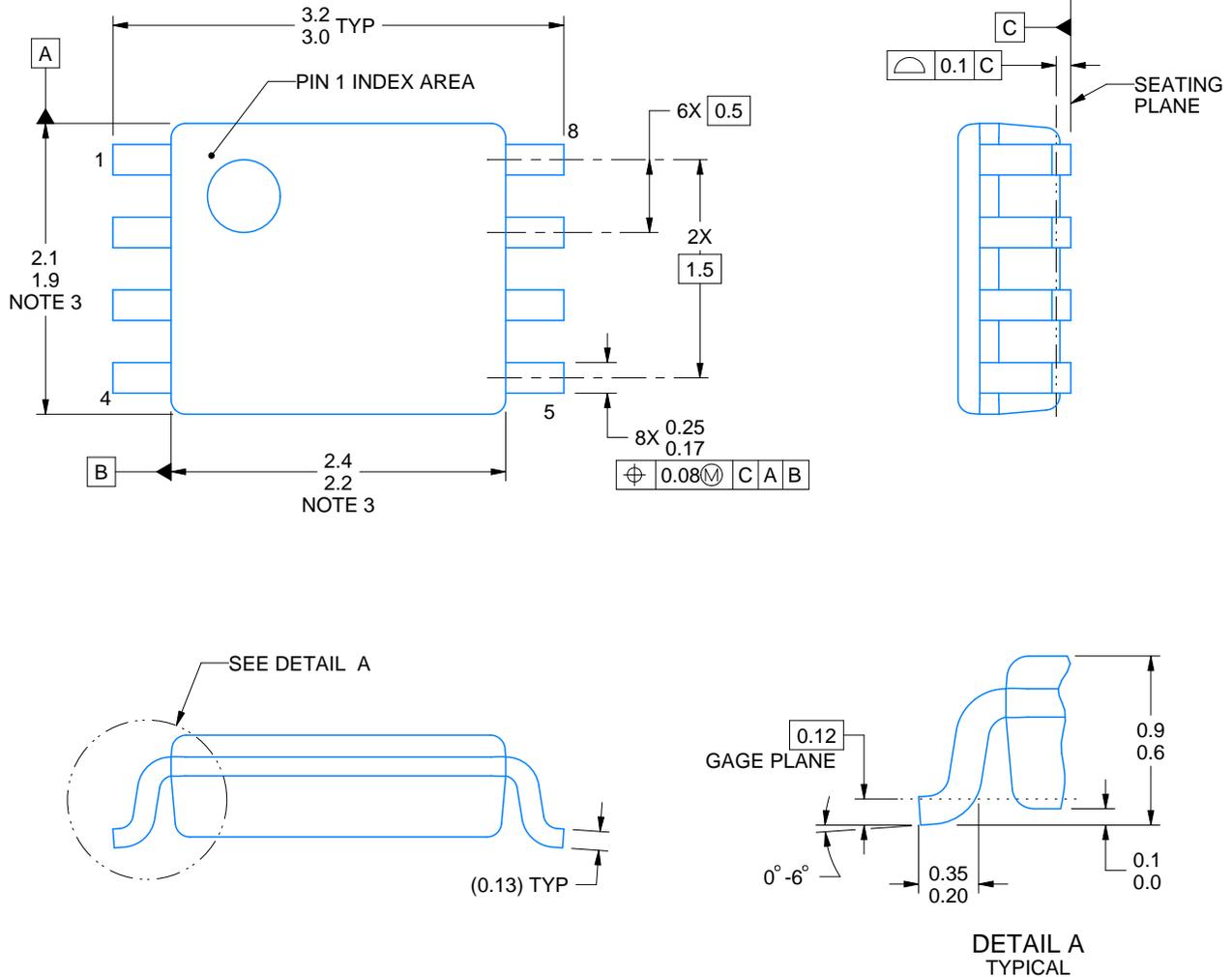
# DCU0008A



# PACKAGE OUTLINE

## VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



4225266/A 09/2014

### NOTES:

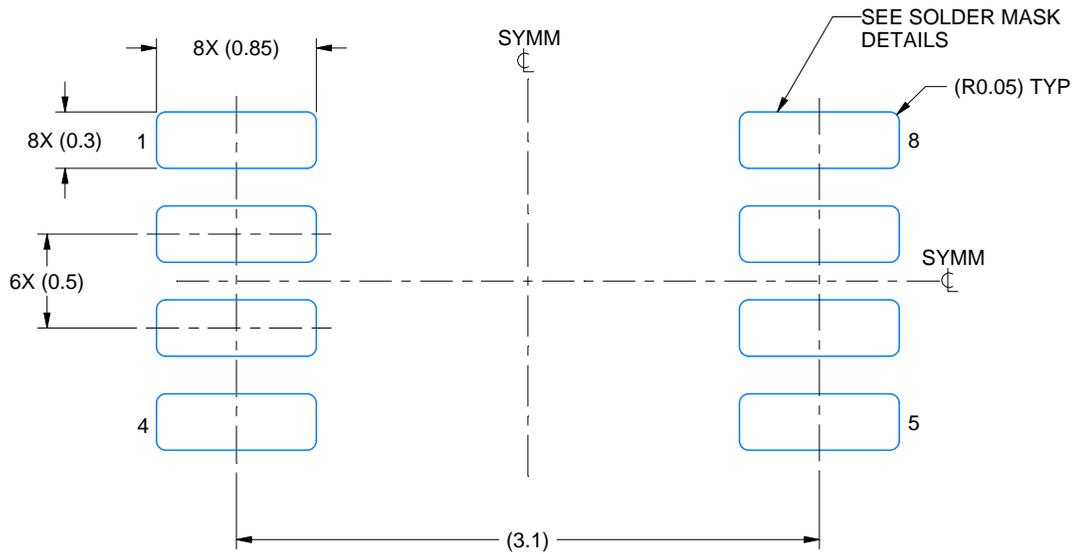
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-187 variation CA.

# EXAMPLE BOARD LAYOUT

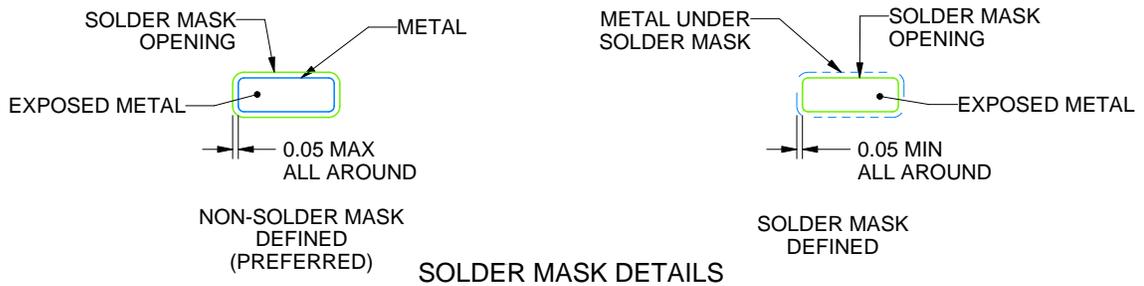
DCU0008A

VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 25X



4225266/A 09/2014

NOTES: (continued)

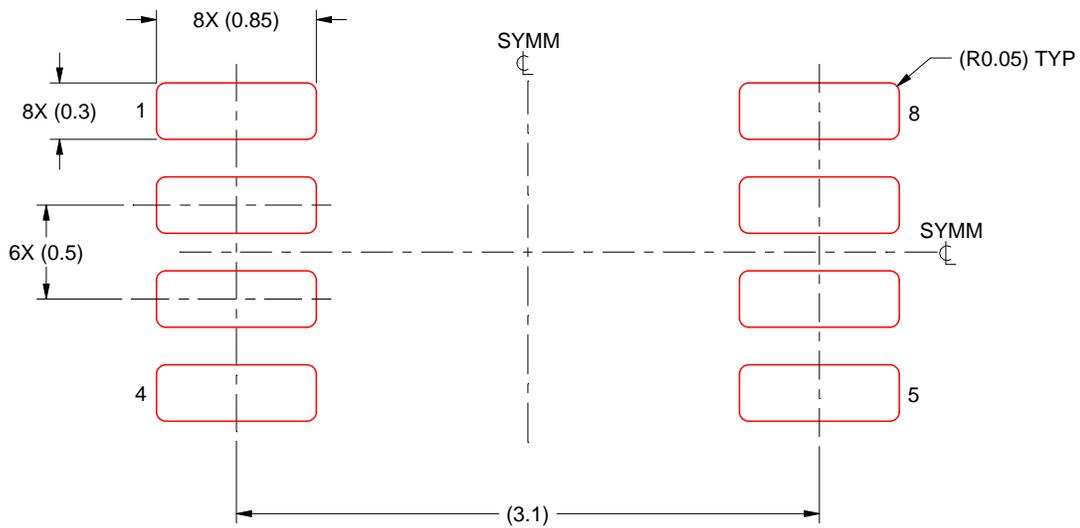
- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DCU0008A

VSSOP - 0.9 mm max height

SMALL OUTLINE PACKAGE



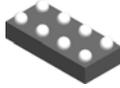
SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 25X

4225266/A 09/2014

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

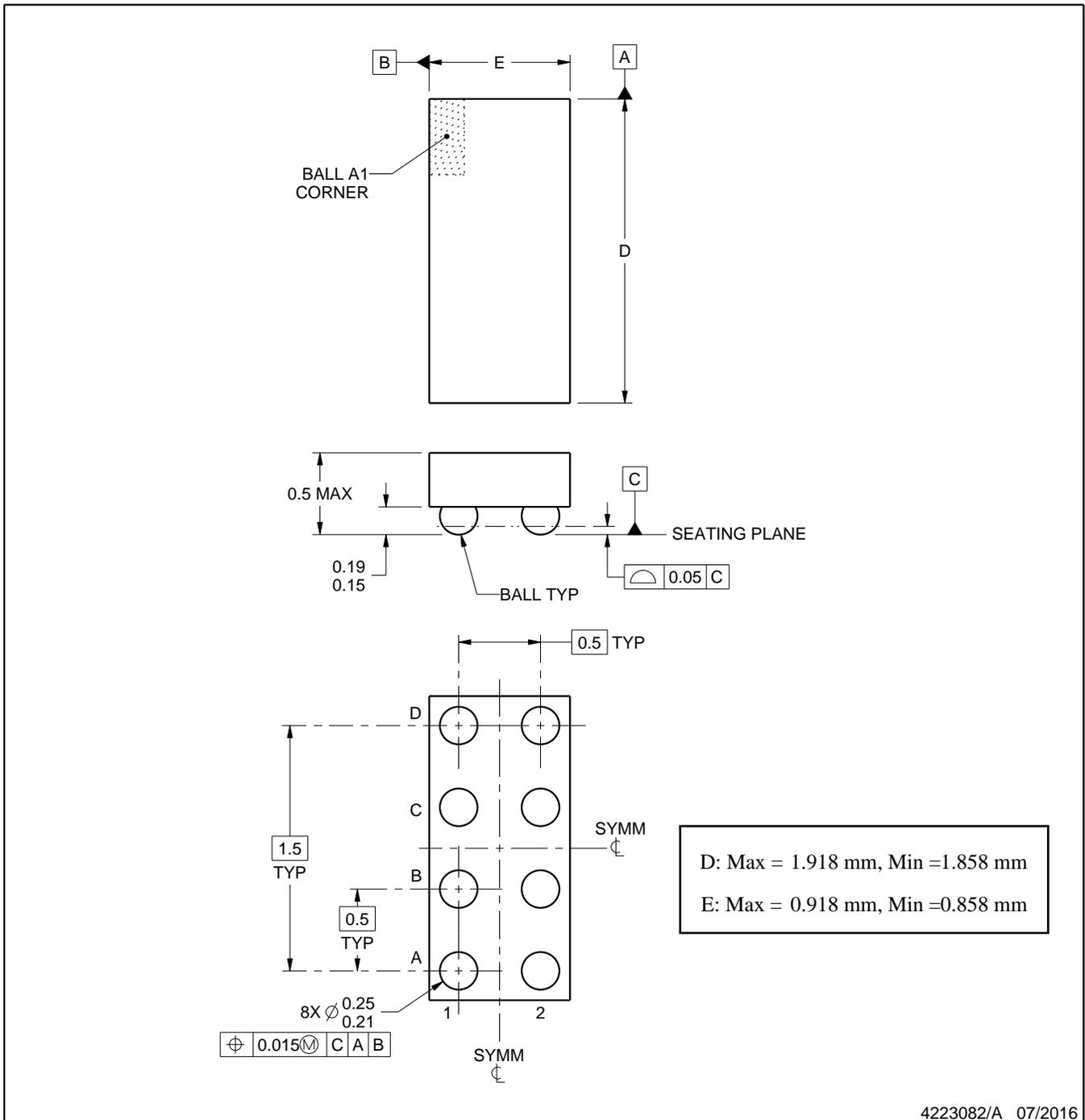
YZP0008



# PACKAGE OUTLINE

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



4223082/A 07/2016

NOTES:

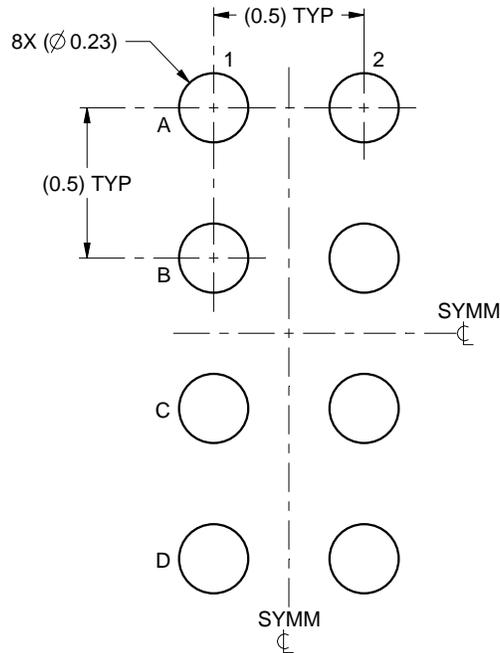
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

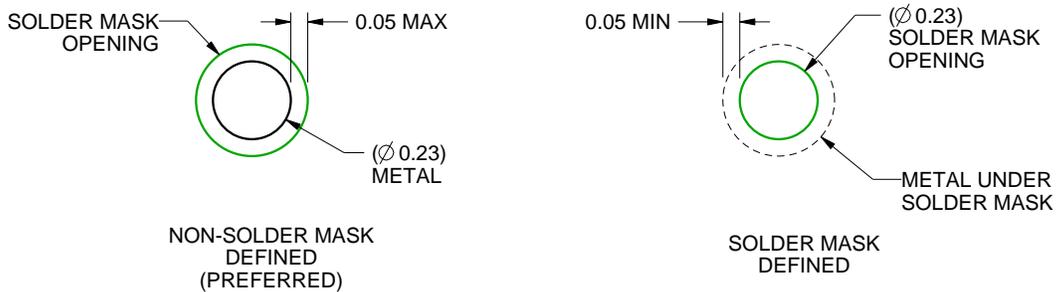
YZP0008

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:40X



SOLDER MASK DETAILS  
NOT TO SCALE

4223082/A 07/2016

NOTES: (continued)

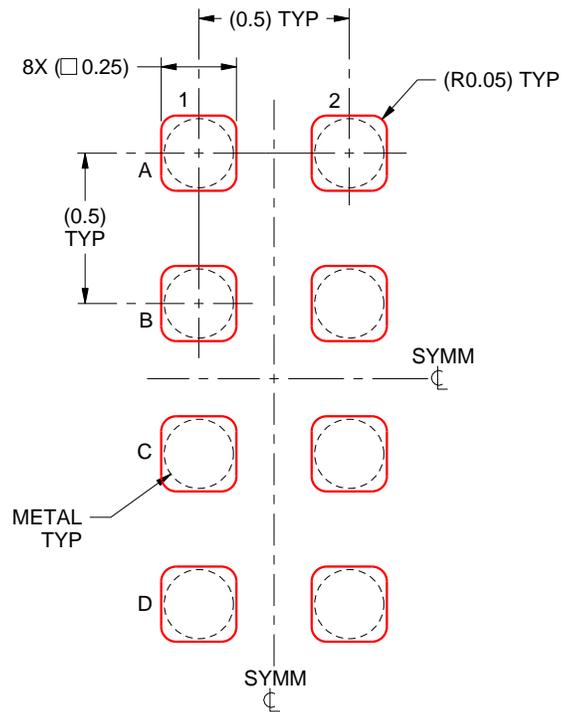
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

# EXAMPLE STENCIL DESIGN

YZP0008

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:40X

4223082/A 07/2016

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

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